











#### www.vectorelect.com

# **IBM AT/ISA** Circuit Pattern:

Width/Thick: Height: 16-Pin DIP Capacity: Material: V/G Terminals: Socket Pins: Extender: Hole Diameter:

# 4617-1

Circuit Pattern: Contacts:

Width/Thick: Height: 16-Pin DIP Capacity: Material: V/G Terminals: Socket Pins: Extender: Hole Diameter:

### 4617-3

Circuit Pattern: Contacts:

Width/Thick: Height: 16-Pin DIP Capacity: Material: V/G Terminals: Socket Pins: Extender: Hole Diameter:

#### 4617-4

Circuit Pattern: Contacts:

Width/Thick: Height: 16-Pin DIP Capacity: Material: Socket Pins: Extender: Hole Diameter:

## **IBM PC, XT**

4613 Circuit Pattern: Contacts: Width/Thick: Height: 16-Pin DIP Capacity: Material: V/G Terminals: Socket Pins: Extender: Hole Diameter:

 $\triangle$ 

3-hole Solder Pad 98 @ .1" Ctrs Ni/Gold 3.25"/.062" 4.5" 44 FR4 Epoxy Glass T44, T46, T49, T68 R32 3690-26, 3690-26-1 .042"

Peripheral Buses 98 @ .1" Ctrs Ni/Gold 13.25"/.062" 4 5" 108 FR4 Epoxy Glass T44, T46, T49, T68 R32 3690-26, 3690-26-1 .042"

Pad-Per-Hole 98 @ .1" Ctrs Ni/Gold 13.25"/.062" 4.5" 96 FR4 Epoxy Glass T44, T46, T49, T68 R32 3690-26, 3690-26-1 .042"

Voltage Ground Plane 98 @ .1" Ctrs Ni/Gold 13.25"/.062" 4.5" 140 FR4 Epoxy Glass

R50, R51, R52, R53 3690-26, 3690-26-1 .055"

## **IBM PC, XT**

3-Hole Solder Pad 31/62 @ .1" Ctrs Ni/Gold 13.25"/.062" 4.2" 93 FR4 Epoxy Glass T44, T46, T49, T68 R32 3690-26 .042"

Plug • 0.100" grid •3-Hole Solder Pads (0.28" x bord 0.080"0 for interconnecting multiple component leads •10 x 42 hole grid unrestricted component placement area •I/O mounting area for up to 70-

pin D-subminiature and ribbon cable Mounting Bracket and hardware kit included (HD36B) ·Layout paper and instructions includ-Row and column legends provided

VECTOR

 0.100" grid
 Bus surfaces solder-coated for con-venience •I/O mounting area for 37-pin D-sub-miniature and ribbon cable connectors Mounting Bracket and hardware kit included (HD36B) •Layout paper and instructions included •Row and column legends provided

0.100" grid
Voltage and ground buses around board perimeter •Pad and bus surfaces solder-coated for convenience •I/O mounting area for up to 70-pin D-subminiature and ribbon . cable connectors •Mounting Bracket and hardware kit included (HD36B) •Layout paper and instructions included ·Hole position legend provided, both sides •Plate thru holes

• 0.100" grid •Plane surfaces solder-coated for user convenience •To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins) ·Layout paper and instructions included

 Mounting Bracket and hardware kit included (HD36B) •I/O mounting area for up to 70-pin D-subminiature and ribbon cable connectors

> 0.100" grid
>  ·3-Hole Solder Pads (0.28" x
>  0.080"0 for interconnecting multiple component leads •I/O mounting area for 37-pin Dsubminiature and ribbon cable connectors ·Mounting Bracket and hardware kit included (HD36B) Lavout paper and instructions included

800-423-5659



# **Mouser Electronics**

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